



Part Number : 2010300214

Product Description : Combo 3-in-2 (nano-SIM and microSD or Dual nano-SIM) Connector, 1.45mm Height, Pin-Eject Type, 8-Circuit microSD Card Type, 6-Circuit nano-SIM Card Type, Tray Capable

Series Number : 201030


Status : Obsolete

Product Category : Memory / SIM Card Connectors

Documents & Resources

Product Environment Compliance

Compliance

| | |
|--------------------|---|
| GADSL/IMDS | Not Relevant |
| China RoHS |  |
| EU ELV | Not Relevant |
| Low-Halogen Status | Low-Halogen per IEC 61249-2-21 |
| REACH SVHC | Not Contained per D(2024)4144-DC (27 June 2024) |
| EU RoHS | Compliant per EU 2015/863 |

Multiple Part Product Compliance Statements

- Eu RoHS
- REACH SVHC
- Low-Halogen

Multiple Part Industry Compliance Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

| | |
|--------|----------|
| Status | Obsolete |
|--------|----------|

| | |
|----------------|--|
| Category | Memory / SIM Card Connectors |
| Series | 201030 |
| Description | Combo 3-in-2 (nano-SIM and microSD or Dual nano-SIM) Connector, 1.45mm Height, Pin-Eject Type, 8-Circuit microSD Card Type, 6-Circuit nano-SIM Card Type, Tray Capable |
| Comments | Tray is customer sourced. |
| Product Family | SD and SIM Memory Card Sockets |
| Product Name | Combo,microSD Card,nano-SIM |
| Style | Pin-Eject |
| UPC | 889056852463 |

Electrical

| | |
|-------------------------------|-----------------|
| Current - Maximum per Contact | 0.5A |
| Voltage - Maximum | 10V AC (RMS)/DC |

Physical

| | |
|--------------------------------|----------------------------|
| Card Detection Switch | Open |
| Card Entry Location | Front |
| Circuits (Loaded) | 12, 14 |
| Circuits (maximum) | 12, 14 |
| Color - Resin | Black |
| Durability (mating cycles max) | 5000 |
| Ejector Button Side | Left |
| Material - Contact | Copper Alloy |
| Material - Plating Mating | Gold over Palladium Nickel |
| Material - Plating Termination | Gold over Palladium Nickel |
| Material - Resin | Liquid Crystal Polymer |
| Material - Shell | Stainless Steel |
| Net Weight | 1.097/g |
| Packaging Type | Embossed Tape on Reel |
| PCB Retention | None |
| Pitch - Mating Interface | 1.10mm, 2.54mm |
| Temperature Range - Operating | -40° to +85°C |
| Termination Interface Style | Surface Mount |

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